Kingbright

2.0x1.25mm SMD CHIP LED LAMP

Part Number: APTK2012SURC HYPER RED

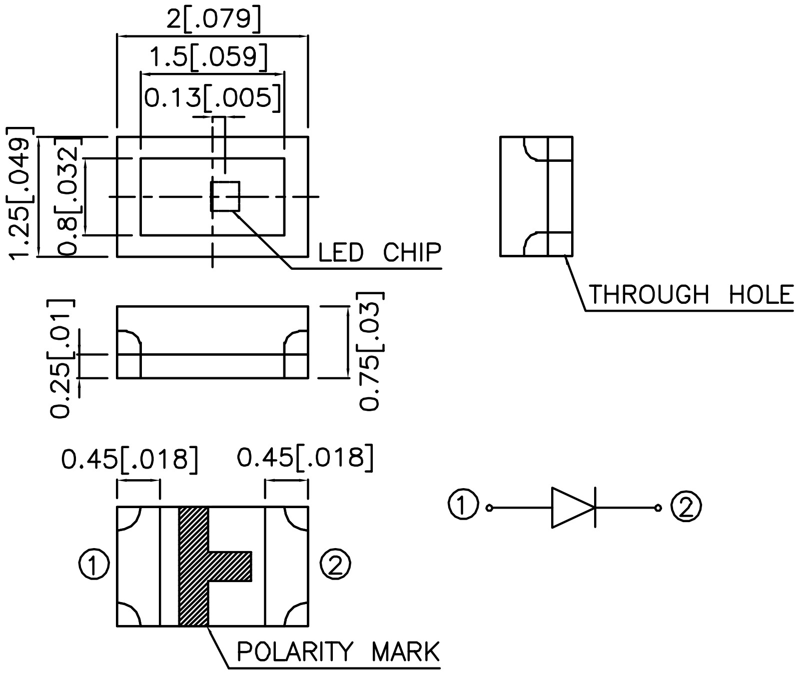
Features

- 2.0mmx1.25mm SMT LED, 0.75mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACK LIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE : 2000PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- RoHS COMPLIANT.

Description

The Hyper Red source color devices are made with DH InGaAlP on GaAs substrate Light Emitting Diode.

Package Dimensions



Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.1(0.004") unless otherwise noted.
3. Specifications are subject to change without notice.

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
APTK2012SURC	HYPER RED (InGaAlP)	WATER CLEAR	110	250	100°

Notes:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. Luminous Intensity / Luminous Flux: +/-15%.

Electrical / Optical Characteristics at T_A=25°C

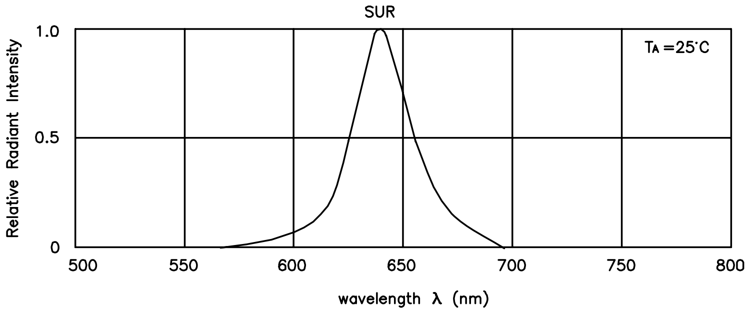
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	640		nm	I_F=20mA
λD [1]	Dominant Wavelength	Hyper Red	628		nm	I_F=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	27		nm	I_F=20mA
C	Capacitance	Hyper Red	45		pF	V_F=0V;f=1MHz
V_F [2]	Forward Voltage	Hyper Red	1.9	2.5	V	I_F=20mA
I_R	Reverse Current	Hyper Red		10	uA	V_R = 5V

Notes:
1. Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at T_A=25°C

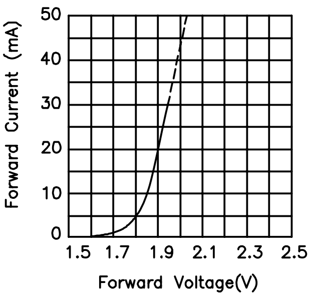
Parameter	Hyper Red	Units
Power dissipation	170	mW
DC Forward Current	30	mA
Peak Forward Current [1]	185	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

Note:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

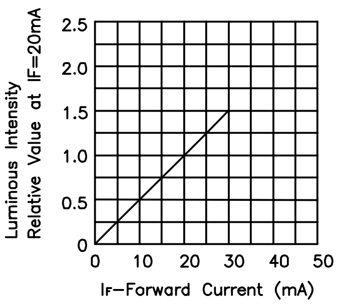


RELATIVE INTENSITY Vs. WAVELENGTH

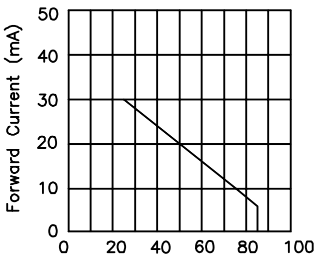
Hyper Red **APTK2012SURC**



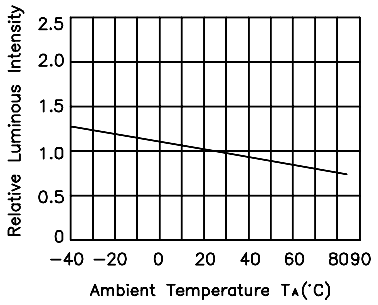
FORWARD CURRENT Vs.
FORWARD VOLTAGE



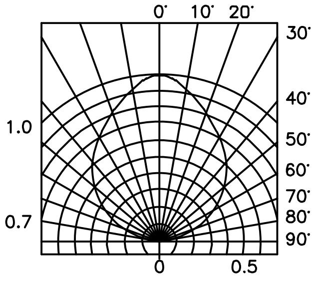
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE



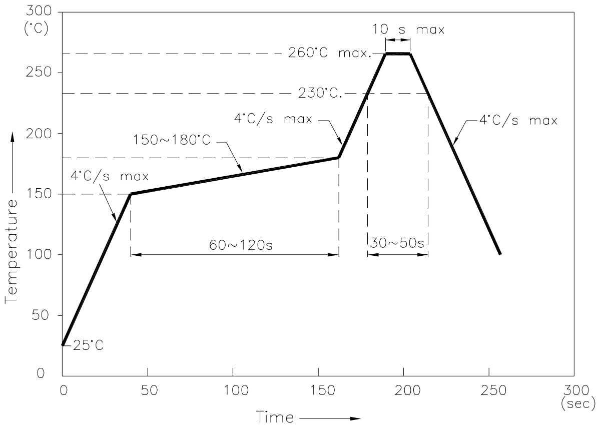
LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

APTK2012SURC

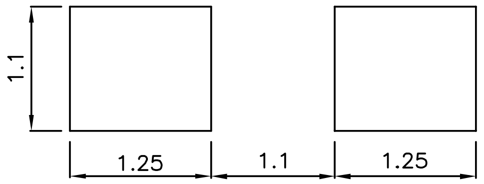
Reflow Soldering Profile For Lead-free SMT Process.



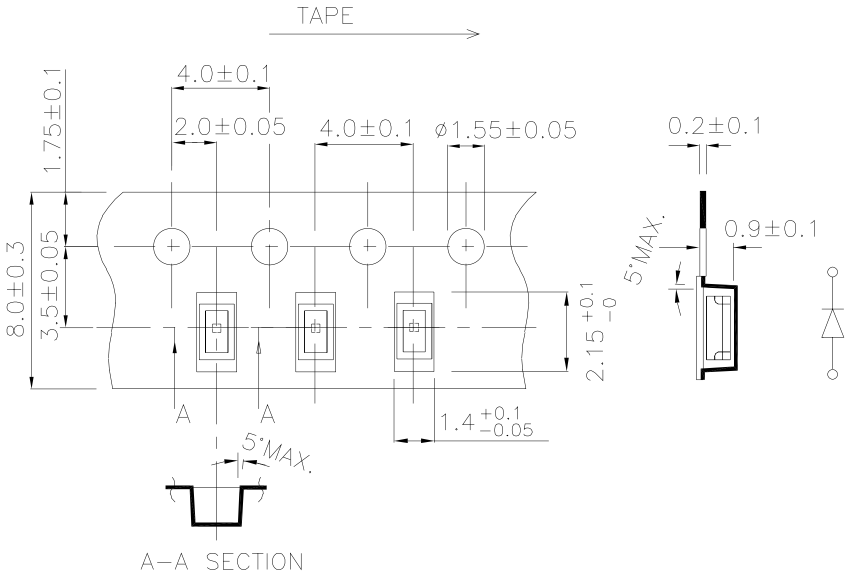
NOTES:

1. We recommend the reflow temperature 245°C(+/−5°C).The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

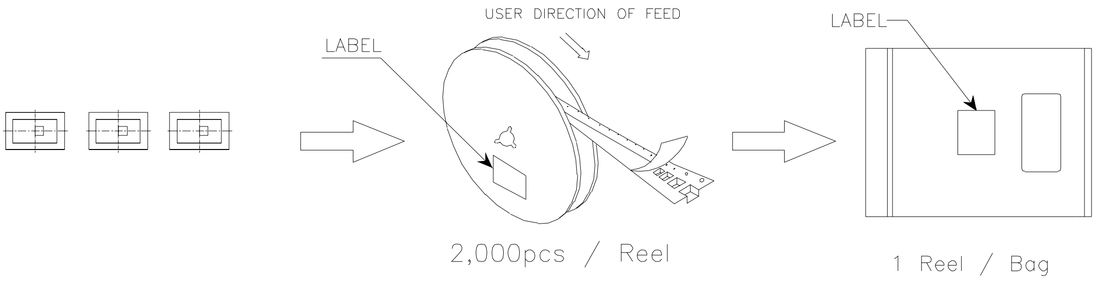
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)

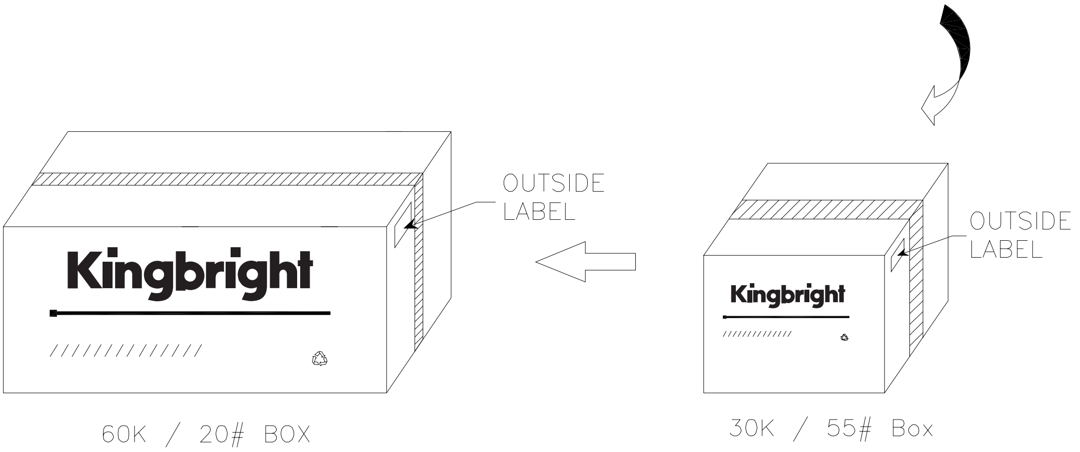


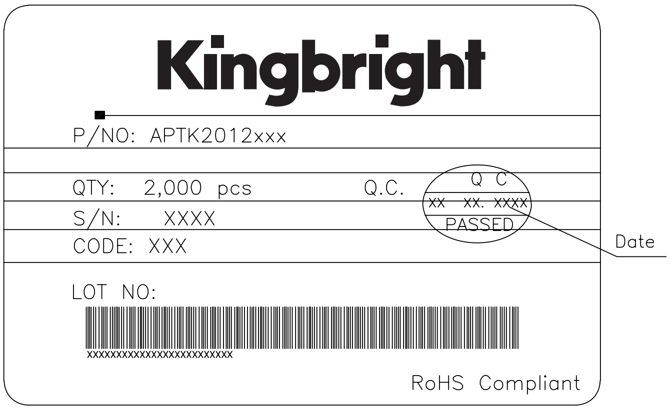
Tape Specifications (Units : mm)



PACKING & LABEL SPECIFICATIONS APTK2012SURC







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P/NO: APTK2012xxx

QTY: 2,000 pcs Q.C.

S/N: XXXX

CODE: XXX

LOT NO:

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RoHS Compliant